



SIZE	QTY	SYM	PLTD
40	9	⊗	PLTD
15	22	U	PLTD
80	1	V	NPLTD
35	277	W	PLTD
94	11	X	PLTD
125	8	Y	PLTD
205	6	Z	PLTD

NOTES : Unless Otherwise Specified

- 1. MATERIAL : FR4 OR EQUIVALENT EPOXY, 2 OZ. COPPER CLAD
THICKNESS .062 +/- .006 TOTAL OF 4 LAYERS
- 2. FINISH : ALL PLATED HOLES .001 MIN. / .0015 MAX. COPPER PLATE
ELECTRODEPOSITED TIN-LEAD COMPOSITION
BEFORE REFLOW , SOLDER MASK OVER BARE COPPER (SMOBC)
- 3. SOLDER MASK : BOTH SIDES USING LPI OR EQUIVALENT
- 4. SILKSCREEN : USING WHITE NON-CONDUCTIVE EPOXY INK
- 5. ALL DIMENSIONS ARE IN INCHES

- ART01 = LAYER 1 (COMPONENT SIDE)
- ART02 = LAYER 2 (GND & VOUT)
- ART03 = LAYER 3 (GND)
- ART04 = LAYER 4 (SOLDER SIDE)

Fabrication Drawing